

## **Call for Papers and Workshops**

The *inaugural IEEE International Conference* on Additively Manufactured Electronic Systems (IEEE AMES 2025) is seeking high-quality submissions for papers (see submission options below) in all areas of technical AMES research and application. IEEE AMES 2025 offers a unique opportunity to share, discuss, and witness research results in all areas of additively manufactured electronics and their applications. Come join us in Atlanta, GA, April 2025!

### **General Track Topics**

- Additively Manufactured Antennas and RF
  - Printable and Flexible RF circuits
  - 3D Printed RF Circuits
  - Adhesive transfer antenna technology
  - Non-conformal Arrays
- Wide-Area Circuit Processing
  - Large scale manufactured systems
- Additively manufactured energy storage
  - Batteries
  - Super Capacitors

- Additively Manufactured Optical Systems
  - Solar cell and photodetector arrays
  - Displays and indicators
  - Lighting/illumination
- Additively manufactured packaging and interconnects
  - Electronics packaging
  - · Printed interconnects
- Additively Manufactured Electronics for Computing
  - · Sensors and embedded systems
  - Computational platforms

### **Workshop Topics**

- Workshop on Additively Manufactured Electronics in Space
  - AMES applications in space
  - Radiation hardening
  - PaddleSats and other ultra-thin satellites

Submit additional workshop proposals to the Workshops Chair at 2025.ieee-ames.org

## **Important Dates**

- Paper Submission Deadline: January 13<sup>th</sup>, 2025
- Workshop Proposal Deadline: October 15<sup>st</sup>, 2024
- Notification of Acceptance: March 10<sup>nd</sup>, 2025
- Final Paper Submission: 31 March 31<sup>st</sup>, 2025
  All Deadlines are at 11:59pm UTC-12

# **Submission options**

- Peer-Reviewed Papers: Full (3 pages)
- Posters

Selected papers will be invited to be published in Journal of Radio Frequency Identification (JRFID)



**Authors of Accepted Papers** receive peer reviews by top AMES technology leaders, get published on IEEE Xplore, and are enrolled in the IEEE AMES 2025 Best Paper Competition ... Don't miss out!

#### **IEEE AMES 2025 Committee**

General co-Chair: General co-Chair: TPC Co-Chairs:

Emmanouil "Manos" Tentzeris, Georgia Tech, US Yang Yang, U of Sydney Technology, Australia Canek Fuentes-Hernandez, Northeastern U, USA Riccardo Colella, U of Salento, Italy